

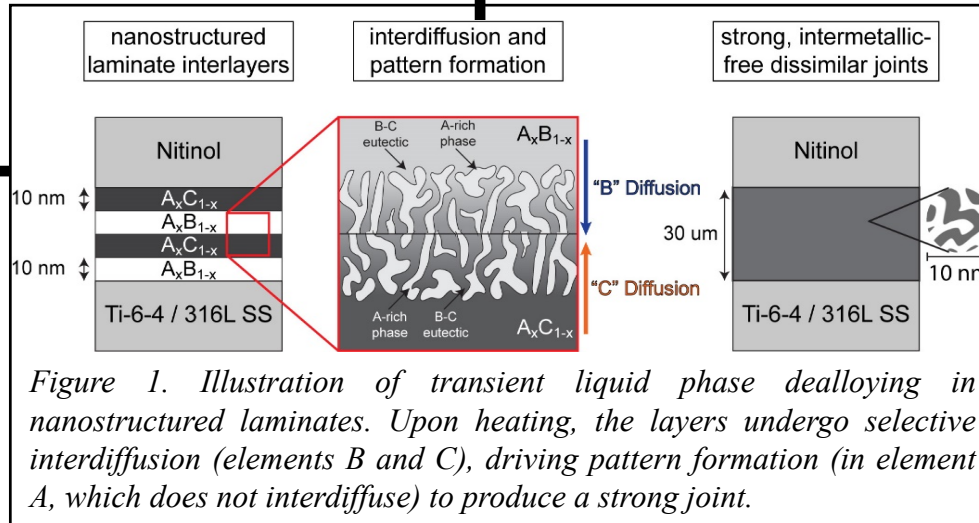
Title

Self-Organized Nanostructured Bonds through Transient Liquid Phase Dealloying

Research Team

Ian D. McCue (PI),
Materials Science and Engineering,
Northwestern University

- This proposal aims to overcome major challenges in joining shape memory alloys through a controlled reaction between nanostructured laminates: interlayers made up of thousands individual layers, 10s of nm thick.
- The proposed bonding technique, **transient liquid phase dealloying (TLPD)**, relies on spontaneous pattern formation during selective interdiffusion to form nanoscale features that span the joint. Our initial work will focus on understanding fundamental reaction kinetics and processing-structure-relationships on bond strength and shape memory/superelastic performance (TRL 1), and progress to bulk interlayer fabrication and demonstration (TRL3) by the end of the effort.



Approach

Thrust 1: Thermodynamic Path Planning to Control Phase Evolution. Design compositional gradients within joints, via computational thermodynamics and path planning algorithms, to avoid intermetallic formation between dissimilar materials.

Thrust 2: Optimal Interlayer Architecture. Determine the ideal interlayer architectures (layer thickness, composition, and modulation) that produce strong, tough joints between NiTi and other materials.

Thrust 3: Scalable Fabrication of Bulk Interlayers. Establish and demonstrate powder fabrication, post-processing, and consolidation protocols to produce free-standing bulk interlayers.

Potential Impact

TLPD will enable the design and fabrication of strong, tough, and intermetallic free joints between shape memory alloys without impeding their functional performance

- Targeting > 90% joint efficiency, >10% strain to failure, with limited impact on shape memory and superelastic response, between Nitinol and: i) two Nitinol-base alloys, ii) Ti-6Al-4V, iii) Inconel 718; and iv) 316-L stainless steel.
- Our interlayers will be beneficial to any dissimilar material joining process where intermetallic formation and cracking is a concern.
- Insights into efficient functional grading can be applied to any layer-by-layer process (e.g., deposition or additive manufacturing).